

CMOS Digital Integrated Circuits Silicon Monolithic

74HC174D

1. Functional Description

• Hex D-Type Flip-Flop with Clear

2. General

The 74HC174D is a high speed CMOS D-TYPE FLIP FLOP fabricated with silicon gate C²MOS technology. It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

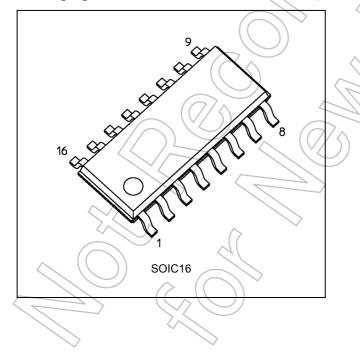
Information signals applied to the D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

When the $\overline{\text{CLR}}$ input is held low, the Q outputs are in the low logic level independent of the other inputs. All inputs are equipped with protection circuits against static discharge or transient excess voltage.

3. Features

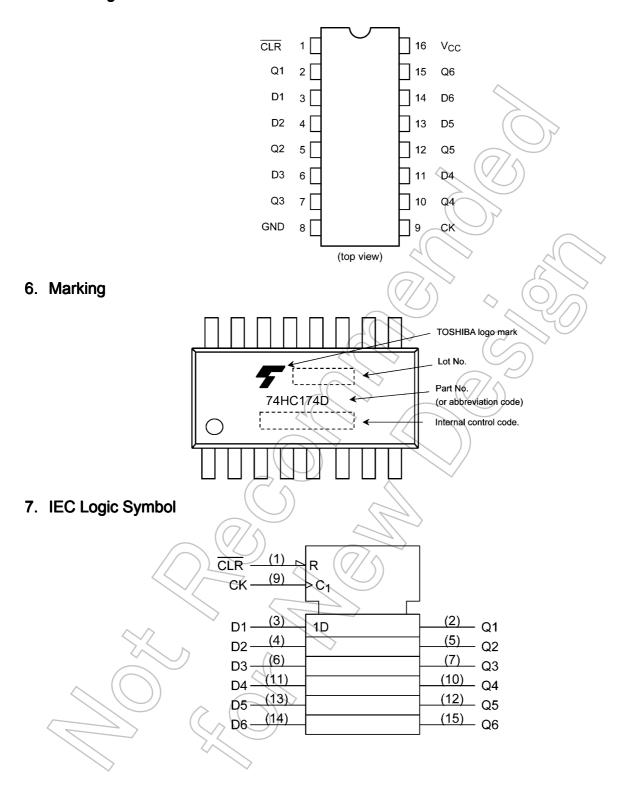
- (1) High speed: $f_{MAX} = 71$ MHz (typ.) at $V_{CC} = 5$ V
- (2) Low power dissipation: $I_{CC} = 4.0 \ \mu A \ (max) \ at \ T_a = 25^{\circ}C$
- (3) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (4) Wide operating voltage range: $V_{CC(opr)} = 2.0$ V to 6.0 V

4. Packaging



5. Pin Assignment

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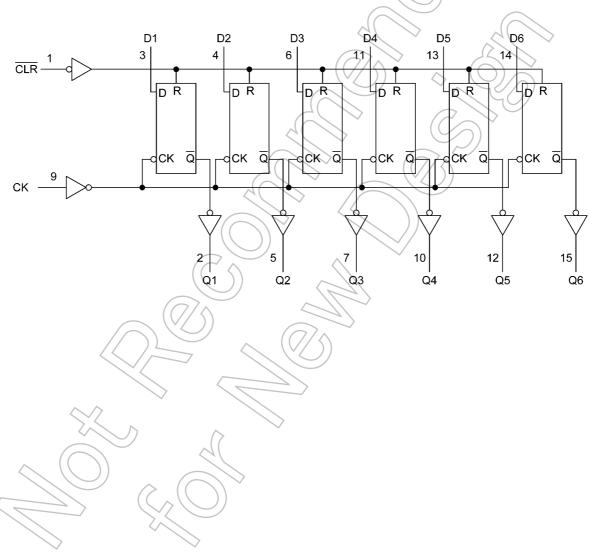
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8. Truth Table

	Inputs		Output	Function
CLR	D	СК	Q	Function
L	Х	Х	L	Clear
н	L		L	—
н	н		Н	_
н	Х	┍→	Qn	No Change

X: Don't care

9. System Diagram



10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to V _{CC} + 0.5	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		±20	mA
Output diode current	I _{ОК}		±20	mA
Output current	I _{ОUT}		±25	mA
V _{CC} /ground current	I _{CC}		±50	mA
Power dissipation	PD		500	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

11. Operating Ranges (Note)

Characteristics	Symbol Test Condition	Rating	Unit
Supply voltage	V _{cc}	2.0 to 6.0	V
Input voltage	VIN))	0 to V _{CC}	V
Output voltage	Vout	0 to V _{CC}	V
Operating temperature	Topr	-40 to 85	°C
Input rise and fall times	t_r, t_f $V_{CC} = 2.0 V$	0 to 1000	ns
	V _{CC} = 4.5 V	0 to 500	
	V _{CC} = 6.0 V	0 to 400	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.



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12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Conditio	on	V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	_	V
				4.5	3.15	_	_	
				6.0	4.20	1		
Low-level input voltage	VIL	—		2.0	_((0.50	~
				4.5			1.35	
				6.0	(// f)	—	1.80	
High-level output voltage	V _{OH}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OH} = -20 μA	2.0	1.9	2.0	_	V
				4.5	4.4	4.5	_	
				6.0	5.9	6.0	_	
			I _{OH} = -4 mA	4.5	4.18	4.31	-	
			I _{OH} = -5.2 mA	6.0	5.68	5.80	\searrow	
Low-level output voltage	V _{OL}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OL} = 20 μA	2.0	_	0.0	0.1	V
				4.5	\diamond	0.0	0.1	
				6.0		0.0	// 0.1	
			I _{OL} = 4 mA	4.5	F	0.17	0.26	
			1 _{0L} = 5.2 mA	6.0		0.18	0.26	
Input leakage current	I _{IN}	$V_{IN} = V_{CC}$ or GND		6.0		_	±0.1	μA
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC} \text{ or } GND$		6.0 (((/ {)	_	4.0	μA

12.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Condition		V _{cc} (V)	Min	Max	Unit
High-level input voltage	VII		\sim	2.0	1.50	_	V
				4.5	3.15		
				6.0	4.20		
Low-level input voltage	Vil	-	7	2.0		0.50	V
	\bigcirc			4.5		1.35	
	1	$\langle \langle \langle \rangle \rangle$		6.0		1.80	
High-level output voltage	V _{он}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9		V
				4.5	4.4		
$\land \land$				6.0	5.9		
	~		I _{OH} = -4 mA	4.5	4.13		
	\sim		I _{OH} = -5.2 mA	6.0	5.63		
Low-level output voltage	VOL	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 20 μA	2.0		0.1	V
	\frown	\searrow		4.5		0.1	
	\bigcirc			6.0		0.1	
	\bigcirc		I _{OL} = 4 mA	4.5	—	0.33	
			I _{OL} = 5.2 mA	6.0		0.33	
Input leakage current	I _{IN}	$V_{IN} = V_{CC}$ or GND		6.0	_	±1.0	μA
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		6.0	_	40.0	μA

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12.3. Timing Requirements (Unless otherwise specified, $T_a = 25^{\circ}$ C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	t _{w(L)} ,t _{w(H)}	_	2.0	75	ns
(CK)			4.5	15	
			6.0	13	
Minimum pulse width	t _{w(L)}	—	2.0	75	ns
(CLR)			4.5	15	
			6.0	13	
Minimum setup time	t _S	- ~ (2.0	75	ns
			4.5	15	
			6.0	13	
Minimum hold time	t _h	- ((2.0	0	ns
			4.5	0	
		$\langle \langle \rangle$	6.0		
Minimum removal time	t _{rem}		2.0	25	ns
(CLR)			4.5	5	
			6.0	(4)	
Clock frequency	f		2.0	6	MHz
			4.5	33	
			6.0	38	

12.4. Timing Requirements (Unless otherwise specified, $T_a = -40$ to 85°C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	t _{w(L)} ,t _{w(H)}	\Box – \checkmark	2.0	95	ns
(CK)	$C \wedge$		4.5	19	
	(())		6.0	16	
Minimum pulse width	t _{w(L)}	$\langle E \rangle$	2.0	95	ns
(CLR)	(5)		4.5	19	
		$\langle (7/5) \rangle$	6.0	16	
Minimum setup time	7 ts		2.0	95	ns
			4.5	19	
\sim			6.0	16	
Minimum hold time	t _h	—	2.0	0	ns
	\wedge	\sim	4.5	0	
	21		6.0	0	
Minimum removal time	trem	_	2.0	30	ns
(CLR)	\bigcirc		4.5	6	
	\bigcirc		6.0	5	
Clock frequency	f		2.0	4	MHz
	\triangleright		4.5	26	
			6.0	30	

12.5. AC Characteristics (Unless otherwise specified, C_L = 15 pF, V_{CC} = 5 V, T_a = 25 °C, Input: t_r = t_f = 6 ns)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Output transition time	t _{TLH} ,t _{THL}		—	_	4	8	ns
Propagation delay time (CK-Q)	t _{PLH} ,t _{PHL}		_	_ <	14	26	ns
Propagation delay time (CLR-Q)	t _{PHL}		_	—	15	26	ns
Maximum clock frequency	f _{MAX}		_	39	71	_	MHz

12.6. AC Characteristics (Unless otherwise specified, $C_L = 50 \text{ pF}$, $T_a = 25 \text{ °C}$, Input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Note	V _{CC} (V)	Min	Тур.	Max	Unit
Output transition time	t _{TLH} ,t _{THL}		2.0	_	27	75	ns
			4.5	_	8	15	
		(()	6.0	- (13	
Propagation delay time	t _{PLH} ,t _{PHL}		2.0	$\Diamond_{-} \lor$	68	150	ns
(CK-Q)			4.5		47	30	
			6.0	$\left(\frac{2}{2}\right)$	14	26	
Propagation delay time	t _{PHL}	$\langle \langle \rangle$	2.0	V-1)	72	150	ns
(CLR-Q)			4.5	$\sum_{i=1}^{n}$	18	30	
			6.0) +	15	26	
Maximum clock frequency	f _{MAX}		2.0	6	15		MHz
			4.5	33	59		
			6.0	38	71		
Input capacitance	CIN	9		_	5	10	рF
Power dissipation capacitance	C _{PD}	(Note 1)		—	40	_	рF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/6$ (per F/F)

And the total C_{PD} when n pcs of flip flop operate can be gained by the following equation.

C_{PD} (total) = 28 + 12 × n

12.7. AC Characteristics (Unless otherwise specified, C_L = 50 pF, T_a = -40 to 85 °C, Input: t_r = t_f = 6 ns)

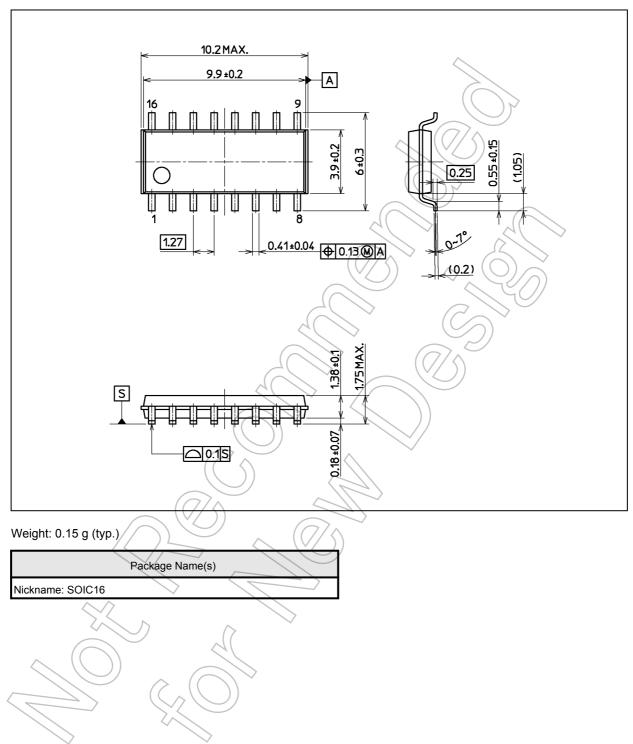
Characteristics	Symbol	Note	V _{CC} (V)	Min	Max	Unit
Output transition time	t _{TLH} ,t _{THL}		2.0	_	95	ns
$\langle (() \rangle \rangle$			4.5	_	19]
	\square		6.0	_	16	
Propagation delay time	t _{PLH} ,t _{PHL}		2.0	_	190	ns
(CK-Q)			4.5	_	38]
	\rightarrow		6.0	—	32	
Propagation delay time	t _{PHL}		2.0	_	190	ns
(CLR-Q)			4.5	_	38]
			6.0	_	32]
Maximum clock frequency	f _{MAX}		2.0	4	_	MHz
			4.5	26	_]
			6.0	30	_]
Input capacitance	C _{IN}		•	—	10	pF



Package Dimensions

74HC174D

Unit: mm



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